

INFLUENCE OF THE HF VAPOR TREATMENT  
ON THE STRUCTURE AND LUMINESCENCE  
PROPERTIES OF POROUS Si/SiO<sub>x</sub>  
NANOCOMPOSITES

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S u m m a r y

By methods of IR-spectroscopy and photoluminescence, we studied the influence of the etching of the oxide matrix of porous nanocomposite Si/SiO<sub>x</sub> structures by HF vapors. The structures were produced by the thermal deposition of silicon monoxide in vacuum at an angle of 60° on c-Si substrates with the subsequent annealing at 975 °C. It is shown that the treatment in HF vapors causes a significant decrease in the volume of a film and a partial additional oxidation of its surface, as well as to the appearance of complexes O<sub>3</sub>SiH and O<sub>2</sub>SiF<sub>2</sub> in the film. On the surface of silicon nanoinclusions, complexes Si<sub>3</sub>SiF arise. Simultaneously, an essential (up to 210 nm) shift of the emission maximum from the infrared range to the visible one of the spectrum and a significant (up to 200 times) increase in the luminescence intensity are observed. These effects can be explained by the process of modification of a structural impurity-involved state of the nanoinclusion-Si-SiO<sub>x</sub> interface as a result of the action of an etcher on a porous film. The light emission intensity grows due to the passivation of broken bonds of silicon on the nanoinclusion-Si-SiO<sub>x</sub> interface by atoms of oxygen and fluorine. The oxidation of the surface of silicon nanoinclusions decreases their size, which is revealed in a short-wave shift of photoluminescence (PL) spectra.